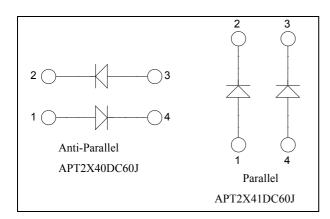


ISOTOP® SiC Diode Power Module

$$V_{RRM} = 600V$$

 $I_F = 40A @ T_C = 100^{\circ}C$



Application

- Uninterruptible Power Supply (UPS)
- Induction heating
- Welding equipment
- High speed rectifiers

Features

- SiC Schottky Diode
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature Independent switching behavior
 - Positive temperature coefficient on VF
- ISOTOP® Package (SOT-227)
- Very low stray inductance
- High level of integration



- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant



Absolute maximum ratings (per leg)

Symbol	Parameter			Max ratings	Unit	
V_R	Maximum DC reverse Voltage			600	V	
V_{RRM}	Maximum Peak Repetitive Reverse Voltage			600	V	
$I_{F(AV)}$	Maximum Average Forward Current	Duty cycle = 50%		$T_{\rm C} = 100^{\circ}{\rm C}$	40	٨
I_{FSM}	Non-Repetitive Forward Surge Cu	petitive Forward Surge Current		$T_C = 25^{\circ}C$	500	Α

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



All ratings @ $T_i = 25^{\circ}C$ unless otherwise specified

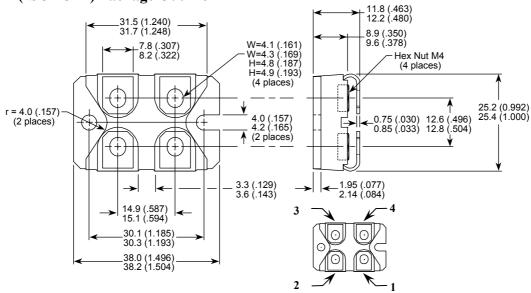
Electrical Characteristics (per leg)

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$V_{\rm F}$	Diode Forward Voltage	$I_F = 40A$	$T_i = 25^{\circ}C$		1.6	1.8	V
			$T_i = 175$ °C		2	2.4	
I_{RM}	Maximum Reverse Leakage Current	$V_R = 600V$	$T_i = 25^{\circ}C$		200	800	
			$T_i = 175$ °C		400	4000	μΑ
Qc	Total Capacitive Charge	$I_F = 40A, V_R = 300V$ di/dt = 1200A/ μ s			56		nC
С	Total Capacitance	$f = 1 MHz, V_R = 200V$			260		pF
		$f = 1MHz, V_R = 400V$			200		

Thermal and package characteristics (per leg)

Symbol	Characteristic	Min	Тур	Max	Unit
R_{thJC}	Junction to Case Thermal resistance			0.7	°C/W
R_{thJA}	Junction to Ambient (Diode)			20	C/ VV
V_{ISOL}	RMS Isolation Voltage, any terminal to case t = 1 min, 50/60Hz	2500			V
T_J, T_{STG}	Storage Temperature Range	-55		175	°C
$T_{ m L}$	Max Lead Temp for Soldering:0.063" from case for 10 sec			300	C
Torque	Mounting torque (Mounting = 8-32 or 4mm Machine and terminals = 4mm Machine)			1.5	N.m
Wt	Package Weight		29.2		g

SOT-227 (ISOTOP®) Package Outline

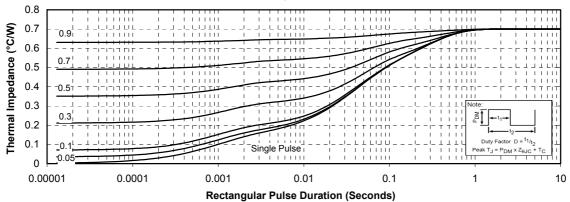


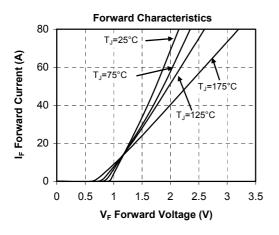
Dimensions in Millimeters and (Inches)

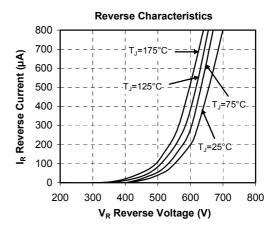


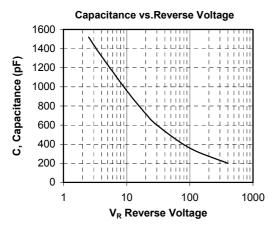
Typical Diode Performance Curve











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